

## Specification for Approval

DEVICE NUMBER: BL-SG0A1278

SAMPLES ATTACHED AREA

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#### FOR CUSTOMER'S APPROVAL STAMP OR SIGNATURE

APPROVED	PURCHASE	MANUFACTURE	QUALITY	ENGINEERING

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**BL-SG0A1278** 

#### Features:

1. Chip material: GaP/GaP (Green) and GaAsP/GaP (Amber)

2. Emitted color : Green and Amber3. Lens Appearance : White Diffused

4. General purpose leads.

5. Low power consumption.

6. Compatible/ low current requirements

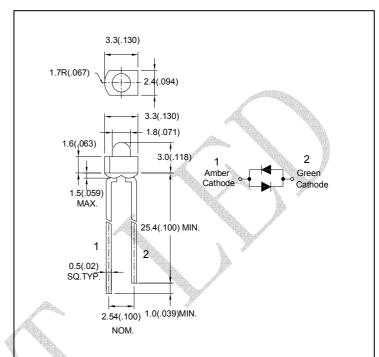
7. Reliable and rugged.

8. This product don't contained restriction substance, compliance RoHS standard.

### Applications:

- 1. TV set
- 2. Monitor
- 3. Telephone
- 4. Computer
- 5. Circuit board

#### Package dimensions:



#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25mm (0.01") unless otherwise specified.
- 3. Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.

### ■ Absolute maximum ratings(Ta=25°C)

Parameter	Symbol	Green	Amber	Unit
Power Dissipation	Pd	80	80	mW
Forward Current	I <sub>F</sub>	30	30	mA
Peak Forward Current*1	I <sub>FP</sub>	150	150	mA
Operating Temperature	Topr	-40℃~85℃		
Storage Temperature	Tstg	-40℃~85℃		

\*1Condition for IEP is pulse of 1/10 duty and 0.1msec width



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#### ■ Electrical and optical characteristics(Ta=25°C)

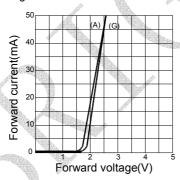
Parameter	Symbol	Condition	Color	Min.	Тур.	Max.	Unit
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =20mA	Green Amber	-	2.2 2.1	2.6 2.6	V
Luminous Intensity	lv	I <sub>F</sub> =20mA	Green Amber	-	15 3	-	mcd
Peak Wave Length	λр	I <sub>F</sub> =20mA	Green Amber	-	568 610	1	nm
Dominant Wave Length	λd	I <sub>F</sub> =20mA	Green Amber	560 600	- -	574 615	nm
Spectral Line Half-width	Δλ	I <sub>F</sub> =20mA	Green Amber	-	30 35	-	nm
Viewing Angle	2θ <sub>1/2</sub>	I <sub>F</sub> =20mA	Green Amber	-	60	-	deg

### Typical electro-optical characteristics curves

Fig.1 Relative intensity vs. Wavelength

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Fig.3 Forward current vs. Forward voltage



vs. Forward current
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Forward current (mA)

Fig.5 Relative luminous intensity

Fig.2 Forward current derating curve vs. Ambient temperature

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Ambient temperature Ta(°C)

Fig.4 Relative luminous intensity vs. Ambient temperature

Notice 1.5

2.0

1.5

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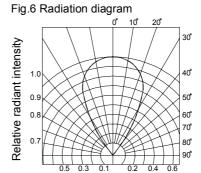
-20

0

20

40

Ambient temperature Ta(°C)





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### Reliability Test

Classification	Test Item	Reference Standard	Test Conditions	Result
	Operation Life	MIL-STD-750:1026 MIL-STD-883:1005 JIS-C-7021 :B-1	I <sub>F</sub> =20mA Ta=+25°ℂ±5°ℂ Test time=1,000hrs	0/32
Endurance	High Temperature High Humidity Storage	MIL-STD-202:103B JIS-C-7021 :B-11	Ta=+85°C±5°C RH=90%-95% Test time=240hrs	0/32
Test	High Temperature Storage	MIL-STD-883:1008 JIS-C-7021 :B-10	High Ta=+85°C±5°C Test time=1,000hrs	0/32
	Low Temperature Storage	JIS-C-7021 :B-12	Low Ta=-45°C±5°C Test time=1,000hrs	0/32
	Temperature Cycling	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1010 JIS-C-7021 :A-4	Ta: $+85^{\circ}$ (30min) ~ $+25^{\circ}$ (5min) ~ $-45^{\circ}$ (30min) ~ $+25^{\circ}$ (5min)  Test Time : 70min/ctcle 10cycle	0/32
Environmental		MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1011	-45°C±5°C ~+85°C±5°C 20min 20min Test Time=10cycle	0/32
Test	Solder Resistance	MIL-STD-202:201A MIL-STD-750:2031 JIS-C-7021 :A-1	Preheating : 120℃,within 120-180 sec. Operation heating : 255℃±5℃ within 5 sec.260℃ (Max)	0/32
	Solderability	MIL-STD-202F:208D MIL-STD-750D:2026 MIL-STD-883D:2003 JIS C 7021:A-2	T.sol=230±5°C Dwell Time=5±1secs	0/32

### Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	V <sub>F</sub> (V)	I <sub>F</sub> =20mA	Over U <sup>1</sup> x1.2
Reverse current	I <sub>R</sub> (uA)	V <sub>R</sub> =5V	Over U <sup>1</sup> x2
Luminous intensity	lv ( mcd)	I <sub>F</sub> =20mA	Below S <sup>1</sup> X0.5

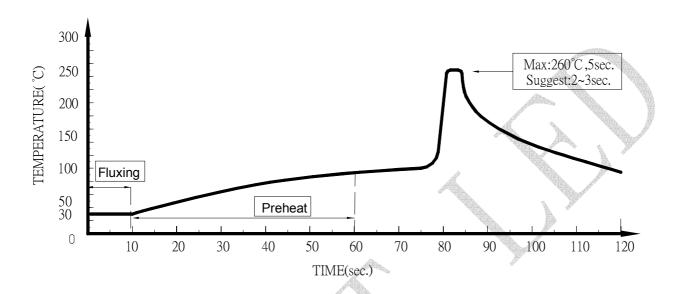
Note: 1. U means the upper limit of specified characteristics. S means initial value.

2. Measurment shall be taken between 2 hours and after the test pieces have been returned to normal ambient conditions after completion of each test.

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### Dip Soldering



- 1. Please avoid any external stress applied to the lead-frames and epoxy while the LEDs are at high temperature, especially during soldering
- 2. DIP soldering and hand soldering should not be done more than one time.
- 3. After soldering, avoid the epoxy lens from mechanical shock or vibration until the LEDs are back to room temerature.
- 4. Avoid rapid cooling during temperature ramp-down process
- Although the soldering condition is recommended above,soldering at the lowest possible temperature is feasible for the LEDs

### ● IRON Soldering

300°C Within 3 sec.,One time only.